

V <sub>DSS</sub>	30V
R <sub>DS(on)</sub> (Max.)	30mΩ
I <sub>D</sub>	±6.0A
P <sub>D</sub>	2.0W

## Features

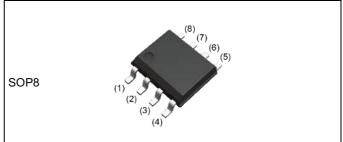
- 1) Low on resistance
- 2) Small Surface Mount Package (SOP8)
- 3) Pb-free plating ; RoHS compliant
- 4) Halogen Free

Application

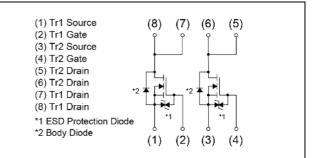
Switching Motor Drive

- 5) Sn100% plating
- 6) AEC-Q101 Qualified

## Outline



#### Inner circuit



## Packaging specifications

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## • Absolute maximum ratings ( $T_a = 25^{\circ}C$ , unless otherwise specified) <Tr1 and Tr2>

Parameter	Symbol	Value	Unit
Drain - Source voltage	V <sub>DSS</sub>	30	V
Continuous drain current	Ι <sub>D</sub>	±6.0	A
Pulsed drain current	I <sub>DP</sub> *1	±24	А
Gate - Source voltage	V <sub>GSS</sub>	±20	V
	P <sub>D</sub> <sup>*2</sup>	2.0	14/
Power dissipation (total)	P <sub>D</sub> *3	1.4	W
Junction temperature	Tj	150	°C
Operating junction and storage temperature range	T <sub>stg</sub>	-55 to +150	°C

#### •Thermal resistance

Deremeter	Sumbol	Values			Unit
Parameter	Symbol	Min.	Тур.	Max.	Unit
Thermal registeres innotion embient (total)	$R_{thJA}^{*2}$	-	-	62.5	°C/W
Thermal resistance, junction - ambient (total)	$R_{thJA}^{*3}$	-	-	89.2	C/VV

## •Electrical characteristics (T<sub>a</sub> = 25°C) <Tr1 and Tr2>

Deremeter	C) mah al	Conditions	Values			Unit	
Parameter	Symbol Conditions -		Min.	Тур.	Max.		
Drain - Source breakdown voltage	V <sub>(BR)DSS</sub>	$V_{(BR)DSS}$ $V_{GS} = 0V, I_D = 1mA$		-	-	V	
Breakdown voltage	ΔV <sub>(BR)DSS</sub>	I <sub>D</sub> = 1mA		29		mV/°C	
temperature coefficient	$\Delta T_j$	referenced to 25°C	-	29	-	mv/ C	
Zero gate voltage drain current	I <sub>DSS</sub>	$V_{\rm DS} = 30V, V_{\rm GS} = 0V$		-	1	μA	
Gate - Source leakage current	I <sub>GSS</sub>	$I_{GSS}$ $V_{GS}$ = ±20V, $V_{DS}$ = 0V		-	±10	μA	
Gate threshold voltage	V <sub>GS(th)</sub>	$V_{GS(th)}$ $V_{DS}$ = 10V, $I_D$ = 1mA		-	2.5	V	
Gate threshold voltage	$\Delta V_{GS(th)}$	I <sub>D</sub> = 1mA		-1.6			
temperature coefficient	$\Delta T_j$	referenced to 25°C	-   -1		-	mV/°C	
		V <sub>GS</sub> = 10V, I <sub>D</sub> = 6A	-	21	30		
Static drain - source on - state resistance	R <sub>DS(on)</sub> *4	V <sub>GS</sub> = 4.5V, I <sub>D</sub> = 6A	-	30	42	mΩ	
		V <sub>GS</sub> = 4.0V, I <sub>D</sub> = 6A	-	33	47		
Gate resistance	R <sub>G</sub>	f = 1MHz, open drain		4.1	-	Ω	
Forward Transfer Admittance	Y <sub>fs</sub>  *4	V <sub>DS</sub> = 10V, I <sub>D</sub> = 6A	4.0	-	-	S	

\*1 Pw  $\leq$  10µs, Duty cycle  $\leq$  1%

- \*2 Mounted on a ceramic board (30×30×0.8mm)
- \*3 Mounted on a Cu board (40×40×0.8mm)

\*4 Pulsed

## •Electrical characteristics ( $T_a = 25^{\circ}C$ ) <Tr1 and Tr2>

Deremeter	Sumphal	Conditions	Values			Unit	
Parameter	Symbol Conditions –		Min.	Тур.	Max.	Unit	
Input capacitance	C <sub>iss</sub>	V <sub>GS</sub> = 0V	-	520	-		
Output capacitance	Dutput capacitance C <sub>oss</sub>		-	150	-	pF	
Reverse transfer capacitance	C <sub>rss</sub>	f = 1MHz	-	95	-		
Turn - on delay time	$t_{d(on)}^{*4}$	$V_{DD} \simeq 15 V, V_{GS} = 10 V$	-	9	-		
Rise time	t <sub>r</sub> *4	I <sub>D</sub> = 3A	-	21	-		
Turn - off delay time	$t_{d(off)}^{*4}$	R <sub>L</sub> = 5Ω	-	36	-	ns	
Fall time	t <sub>f</sub> *4	R <sub>G</sub> = 10Ω	-	13	-		

## •Gate charge characteristics ( $T_a = 25^{\circ}C$ ) <Tr1 and Tr2>

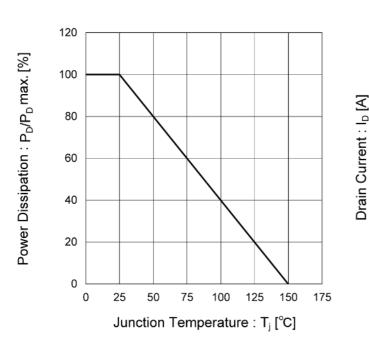
Deremeter	Symbol Conditions		Values			Lincit
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Total gate charge	$Q_g^{*4}$		-	7.2	10.1	
Gate - Source charge	Q <sub>gs</sub> *4	V <sub>DD</sub> ≃ 15V, I <sub>D</sub> = 6A V <sub>GS</sub> = 5V	-	1.8	-	nC
Gate - Drain charge	Q <sub>gd</sub> *4		-	2.8	-	

## ●Body diode electrical characteristics (Source-Drain) (T<sub>a</sub> = 25°C)

<Tr1 and Tr2>

Parameter	Symbol Conditions		Values			Unit
			Min.	Тур.	Max.	UTIIL
Continuous forward current	I <sub>S</sub>	T - 25°0	-	-	1.6	^
Pulse forward current	I <sub>SP</sub> *1	T <sub>a</sub> = 25°C	-	-	6.4	A
Forward voltage	V <sub>SD</sub> *4	V <sub>GS</sub> = 0V, I <sub>S</sub> = 6.4A	-	-	1.2	V





## Fig.1 Power Dissipation Derating Curve

Fig.2 Maximum Safe Operating Area

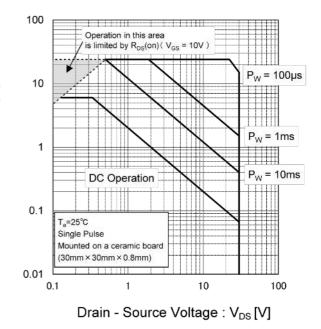
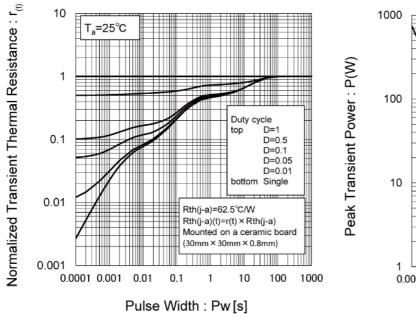
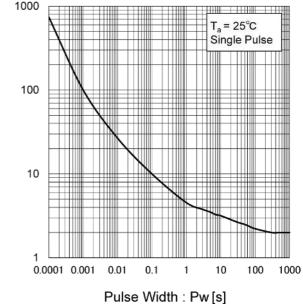


Fig.3 Normalized Transient Thermal Resistance vs. Pulse Width

Fig.4 Single Pulse Maximum Power Dissipation







Drain Current : I<sub>D</sub> [A]

1

0

0

0.5

T<sub>a</sub>=25°C

V<sub>GS</sub>= 2.0V

Pulsed

#### 6 6 $V_{GS} = 10V$ <sub>GS</sub>= 10V 5.5 5.5 V<sub>GS</sub>= 4.5V <sub>GS</sub>= 4.5V T\_=25°C 5 5 V<sub>GS</sub>= 4.0V Pulsed V<sub>GS</sub>= 4.0V V<sub>GS</sub>= 3.5V 4.5 4.5 V<sub>GS</sub>= 3.5V Drain Current : I<sub>D</sub> [A] -V<sub>GS</sub>= 3.0V 4 V<sub>GS</sub>= 3.0V 4 V<sub>GS</sub>= 2.5V V<sub>GS</sub>= 2.5V 3.5 3.5 3 3 2.5 2.5 2 2 1.5 1.5

V<sub>GS</sub>= 2.0V

1

1

0.5

0

0

1

2 3

5

Drain - Source Voltage : V<sub>DS</sub> [V]

6 7 8 9 10

4

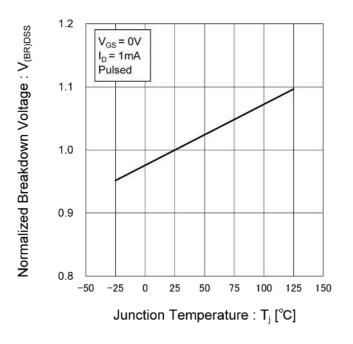
## Fig.5 Typical Output Characteristics(I)

Fig.6 Typical Output Characteristics(II)

Fig.7 Breakdown Voltage vs. Junction Temperature

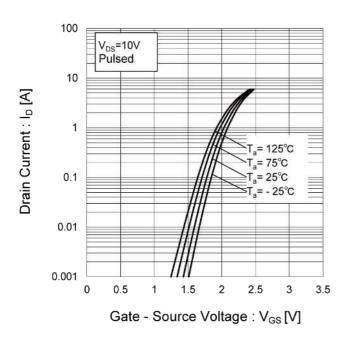
0.1 0.2 0.3 0.4 0.5 0.6 0.7 0.8 0.9

Drain - Source Voltage : V<sub>DS</sub> [V]



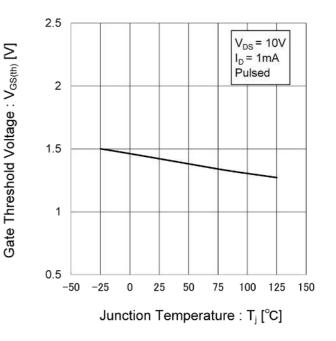




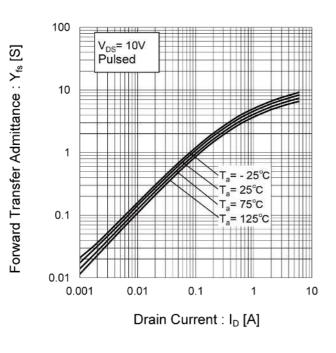


## Fig.8 Typical Transfer Characteristics Fig.

#### Fig.9 Gate Threshold Voltage vs. Junction Temperature



## Fig.10 Forward Transfer Admittance vs. Drain Current







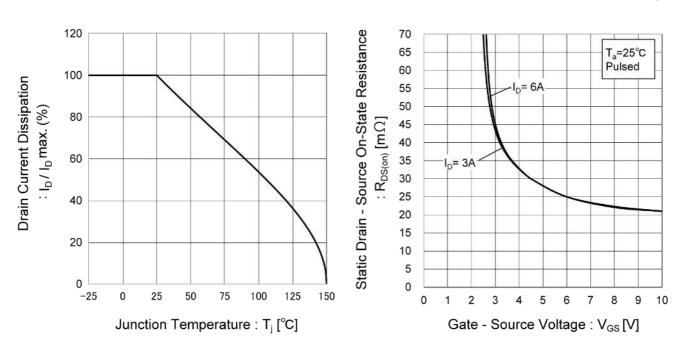


Fig.11 Drain Current Derating Curve

Fig.12 Static Drain - Source On - State Resistance vs. Gate Source Voltage

Fig.13 Static Drain - Source On - State Resistance vs. Junction Temperature

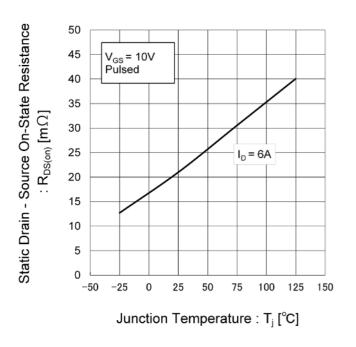




Fig.14 Static Drain - Source On - State

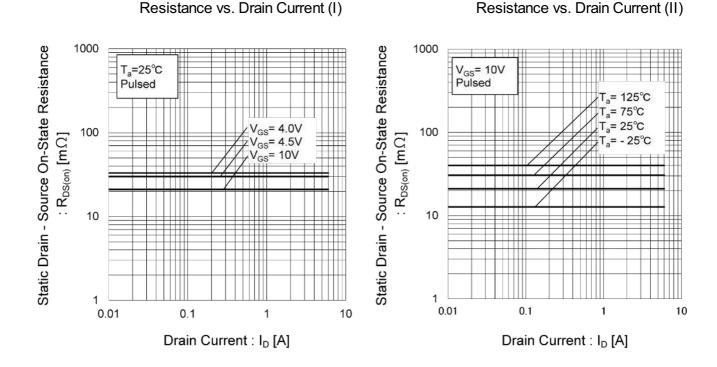
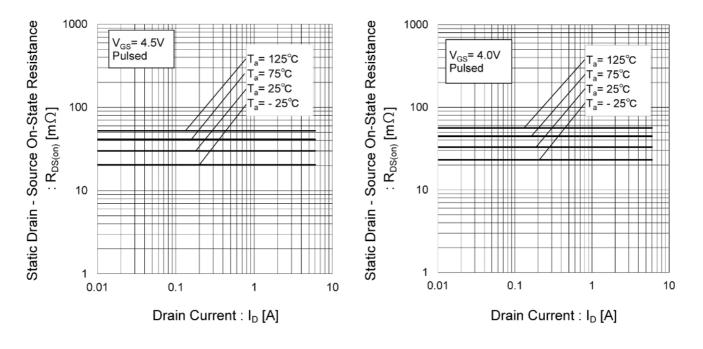


Fig.16 Static Drain - Source On - State Resistance vs. Drain Current (III)

Fig.17 Static Drain - Source On - State Resistance vs. Drain Current (IV)

Fig.15 Static Drain - Source On - State





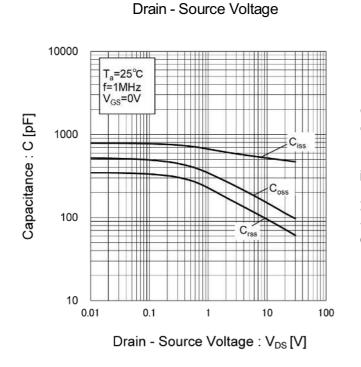


Fig.18 Typical Capacitances vs.

#### Fig.19 Switching Characteristics

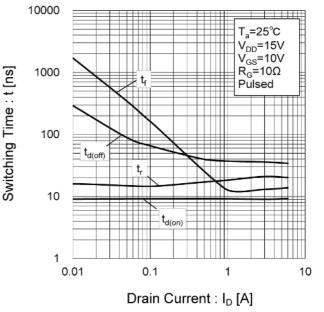


Fig.20 Typical Gate Charge

Gate - Source Voltage : V<sub>GS</sub> [V]

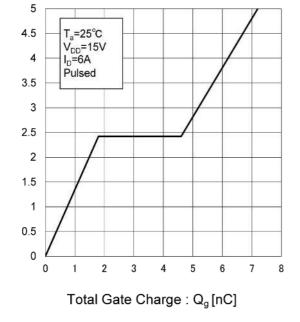
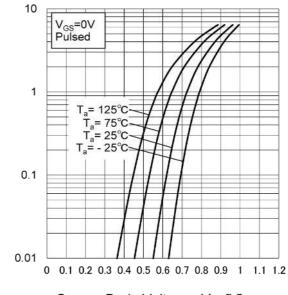


Fig.21 Source Current vs. Source Drain Voltage



Source-Drain Voltage : V<sub>SD</sub>[V]

Source Current :I<sub>S</sub> [A]



## •Measurement circuits <It is the same for the Tr1 and Tr2>



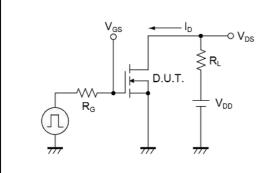


Fig.2-1 Gate Charge Measurement Circuit

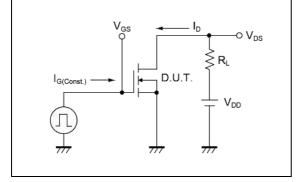
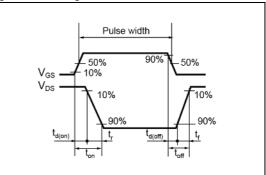
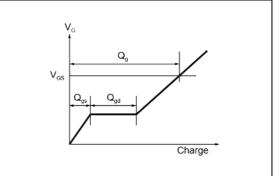


Fig.1-2 Switching Waveforms





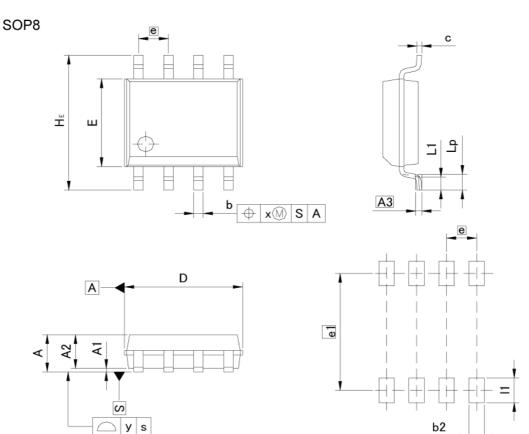






#### SP8K2HZG

#### Dimensions



Pattern of terminal position areas [Not a pattern of soldering pads]

	MILIM	MILIMETERS MIN MAX		HES
	MIN	MAX	MIN	MAX
A	<u>-</u> /	1.75	-	0.069
A1	0.	15	0.0	06
A2	1.40	1.60	0.055	0.063
A3	0.	25	0.0	10
b	0.30	0.50	0.012	0.020
с	0.10	0.30	0.004	0.012
D	4.80	5.20	0.189	0.205
E	3.75	4.05	0.148	0.159
е	1.	27	0.0	50
HE	5.70	6.30	0.224	0.248
L1	0.40	0.60	0.016	0.024
Lp	0.65	0.85	0.026	0.033
x	0.	15	0.0	06
у	0.	10	0.004	

DIM	MILIM	ETERS	INC	HES
DIM	MIN	MAX	MIN	MAX
b2	-	0.65	<del></del>	0.026
e1	5.	15	0.1	203
11	<del></del> 2	1.15	<b>27</b> (2	0.045

Dimension in mm/inches



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 If you intend to use our Products in devices requiring extremely high reliability (such as medical equipment (Note 1), aircraft/spacecraft, nuclear power controllers, etc.) and whose malfunction or failure may cause loss of human life, bodily injury or serious damage to property ("Specific Applications"), please consult with the ROHM sales representative in advance. Unless otherwise agreed in writing by ROHM in advance, ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of any ROHM's Products for Specific Applications.

(Note1) Medical Equipment Classification of the Specific Applications
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JAPAN	USA	EU	CHINA
CLASSII	CLASSI	CLASS II b	CLASSⅢ
CLASSIV	CLASSI	CLASSⅢ	CLASSII

2. ROHM designs and manufactures its Products subject to strict quality control system. However, semiconductor products can fail or malfunction at a certain rate. Please be sure to implement, at your own responsibilities, adequate safety measures including but not limited to fail-safe design against the physical injury, damage to any property, which a failure or malfunction of our Products may cause. The following are examples of safety measures:

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[b] Installation of redundant circuits to reduce the impact of single or multiple circuit failure

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  - [c] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl<sub>2</sub>, H<sub>2</sub>S, NH<sub>3</sub>, SO<sub>2</sub>, and NO<sub>2</sub>
  - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
  - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
  - [f] Sealing or coating our Products with resin or other coating materials
  - [g] Use of our Products without cleaning residue of flux (Exclude cases where no-clean type fluxes is used. However, recommend sufficiently about the residue.); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
  - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse, is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

#### Precaution for Mounting / Circuit board design

- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

#### Precautions Regarding Application Examples and External Circuits

- 1. If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.
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This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

#### Precaution for Storage / Transportation

- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
  - [a] the Products are exposed to sea winds or corrosive gases, including Cl<sub>2</sub>, H<sub>2</sub>S, NH<sub>3</sub>, SO<sub>2</sub>, and NO<sub>2</sub>
  - [b] the temperature or humidity exceeds those recommended by ROHM
  - [c] the Products are exposed to direct sunshine or condensation
  - [d] the Products are exposed to high Electrostatic
- 2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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